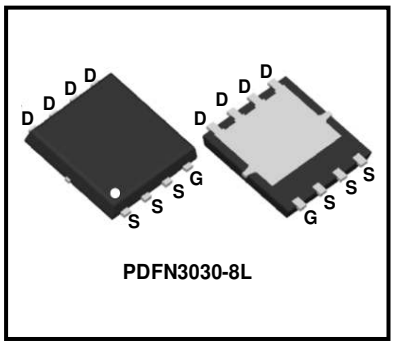
WMQ119N10LG2

100V N-Channel Enhancement Mode Power MOSFET



PDFN3030-8L

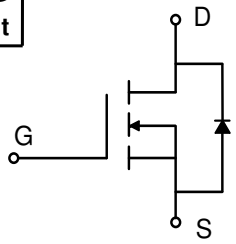
Description

WMQ119N10LG2 uses Wayon's 2nd generation power trench MOSFET technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance. This device is well suited for high efficiency fast switching applications.

Features

- V_{DS} = 100V, I_D = 42A(Silicon limited)
  $R_{DS(on)}$ < 13mΩ @ V_{GS} = 10V
  $R_{DS(on)}$ < 17.5mΩ @ V_{GS} = 4.5V
- Green Device Available
- 100% EAS Guaranteed
- High Speed Power Switching, Logic Level

RoHS compliant



Applications

- Synchronous Rectification in SMPS
- Hard Switching and High Speed Circuit
- DC/DC Converter

Absolute Maximum Ratings

Parameter		Symbol	Value	Unit
Drain-Source voltage		V_{DS}	100	V
Gate-Source voltage		V_{GS}	±20	V
Continuous Drain Current[1](Silicon Limited)	T_C=25℃	I_D	42	A
	T_C=100℃		26	
Continuous Drain Current[1](Package Limited)	T_C=25℃		30	
Pulsed Drain Current[2]		I_{DM}	151	A
Single Pulse Avalanche Energy[3]		EAS	61	mJ
Avalanche Current		I_{AS}	35	A
Total Power Dissipation[4]	T_C=25℃	P_D	42	W
Operating Junction and Storage Temperature Range		T_J , T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient[1]	$R_{\theta JA}$	52	°C/W
Thermal Resistance from Junction-to-Case[1]	$R_{\theta JC}$	3	°C/W

Electrical Characteristics T_c = 25°C, unless otherwise noted

Parameter		Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics							
Drain-Source Breakdown Voltage		$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	100	-	-	V
Gate-body Leakage Current		I_{GSS}	V_{DS} = 0V, V_{GS} = ±20V	-	-	±100	nA
Zero Gate Voltage Drain Current	T_J=25℃	I_{DSS}	V_{DS} = 100V, V_{GS} = 0V	-	-	1	μA
	T_J=100℃			-	-	100	
Gate-Threshold Voltage		$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	1.2	1.8	2.4	V
Drain-Source on-Resistance[2]		$R_{DS(on)}$	V_{GS} = 10V, I_D = 15A	-	11.6	13	mΩ
			V_{GS} = 4.5V, I_D = 8A	-	15.3	17.5	
Forward Transconductance[2]		g_{fs}	V_{DS} = 5V, I_D = 20A	-	45	-	S
Dynamic Characteristics							
Input Capacitance		C_{iss}	V_{DS} = 50V, V_{GS} =0V, f =1MHz	-	1170	-	pF
Output Capacitance		C_{oss}		-	210	-	
Reverse Transfer Capacitance		C_{rss}		-	6.5	-	
Switching Characteristics							
Gate Resistance		R_g	V_{DS}=0V, V_{GS} =0V, f =1MHz	-	0.85	-	Ω
Total Gate Charge		Q_g	V_{GS} = 4.5V, V_{DD} = 50V, I_D= 20A	-	10.8	-	nC
Total Gate Charge		Q_g	V_{GS} = 10V, V_{DD} = 50V, I_D= 20A	-	20	-	
Gate-Source Charge		Q_{gs}		-	4	-	
Gate-Drain Charge		Q_{gd}		-	5	-	
Turn-on Delay Time		$t_{d(on)}$	V_{GS} =10V, V_{DD} = 50V,R_G = 10Ω, I_D= 20A	-	4.9	-	nS
Rise Time		t_r		-	3	-	
Turn-off Delay Time		$t_{d(off)}$		-	14.5	-	
Fall Time		t_f		-	3	-	
Drain-Source Body Diode Characteristics							
Diode Forward Voltage[2]		V_{SD}	I_S = 1A, V_{GS} = 0V	-	-	1	V
Continuous Source Current[1,5,]		I_S	V_G=V_D=0V, Force Current	-	-	42	A
Reverse Recovery Time		t_{rr}	V_R =50V, I_F=20A, dI_F/dt=500A/μs	-	35.5	-	nS
Reverse Recovery Charge		Q_{rr}		-	148	-	nC

Notes:

1.The data tested by surface mounted on a 1 inch^2 FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%

3.The EAS data shows Max. rating . The test condition is V_{DD}=25V, V_{GS}=10V,L=0.1mH, I_{AS}=35A

4.The power dissipation is limited by 150°C junction temperature

5.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

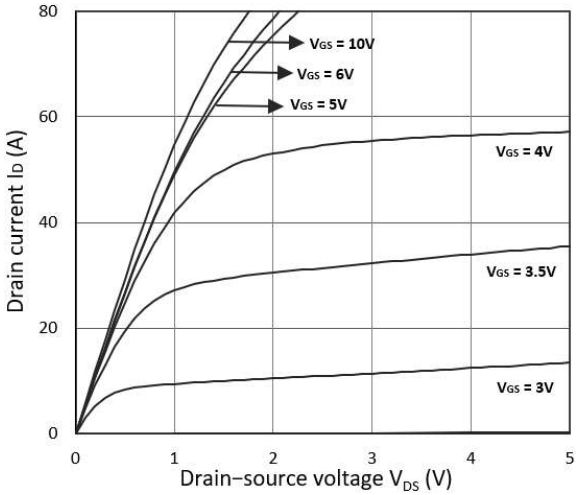


Figure 1. Output Characteristics

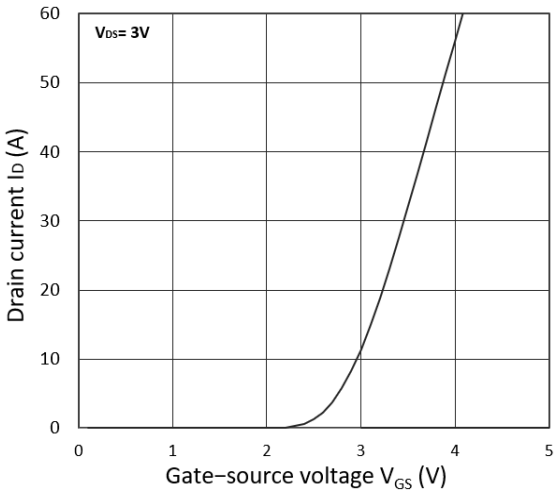


Figure 2. Transfer Characteristics

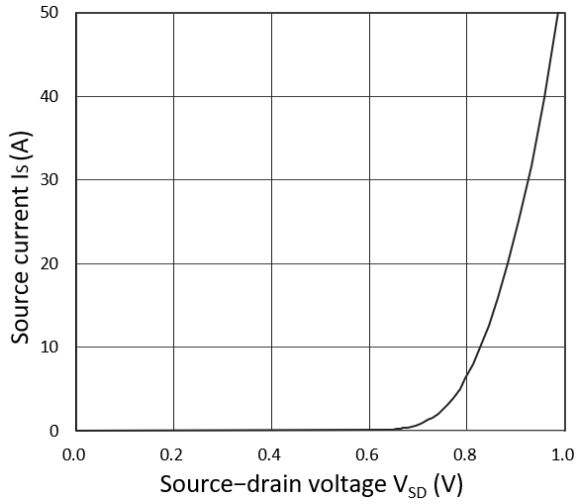


Figure 3. Forward Characteristics of Reverse

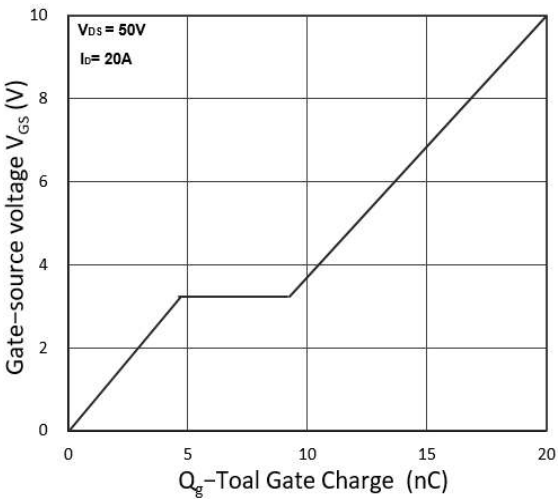


Figure 4. Gate Charge Characteristics

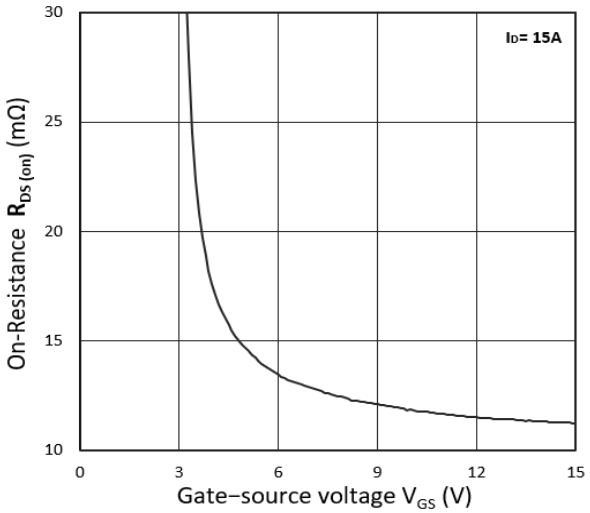


Figure 5. $R_{DS(ON)}$ vs. V_{GS}

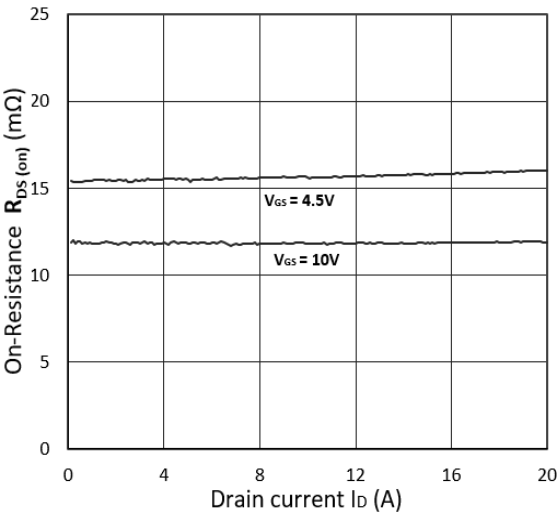


Figure 6. $R_{DS(ON)}$ vs. I_D

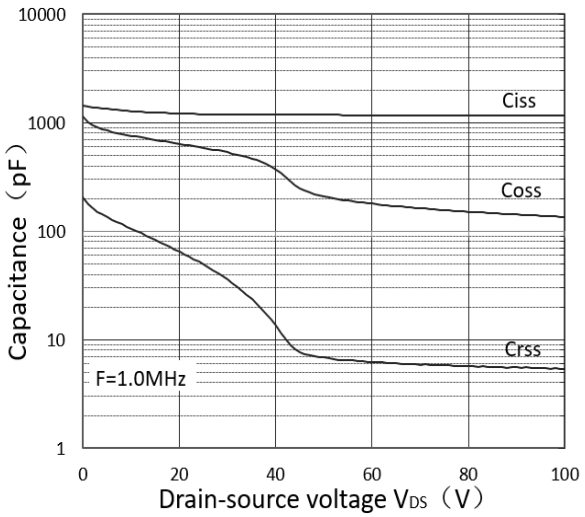


Figure 7. Capacitance Characteristics

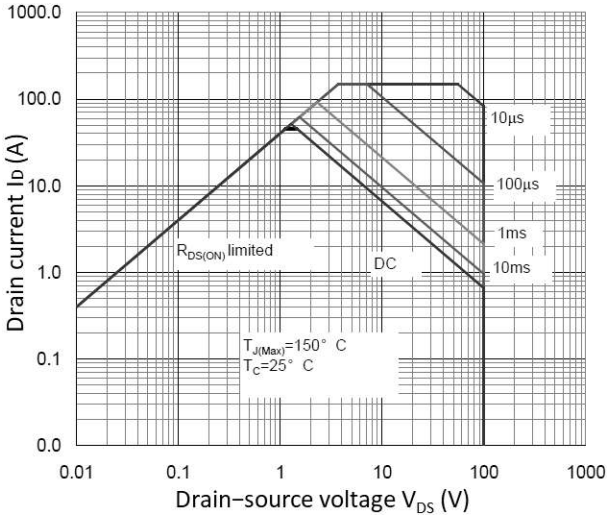


Figure 8. Safe Operating Area

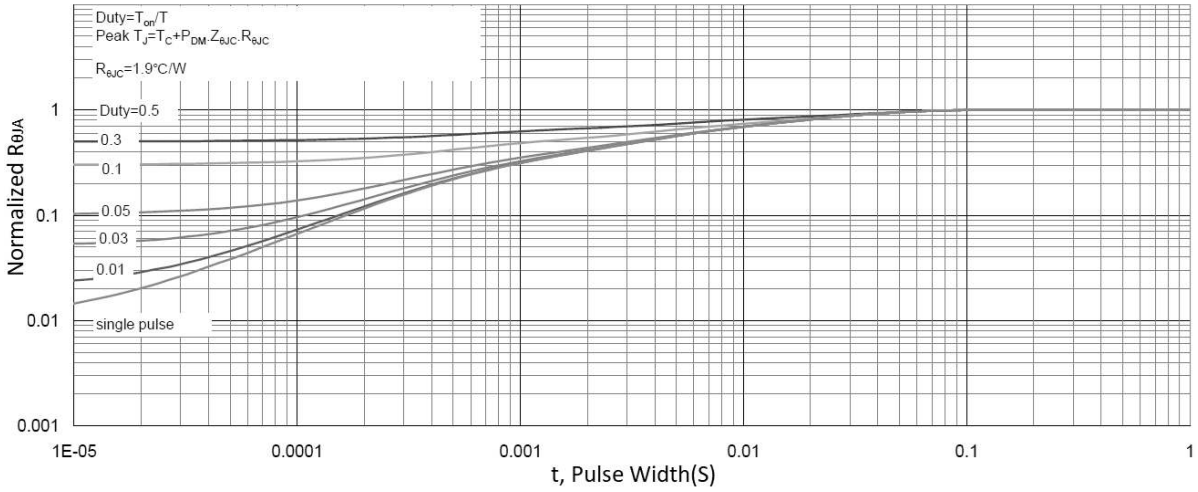


Figure 9. Normalized Maximum Transient Thermal Impedance

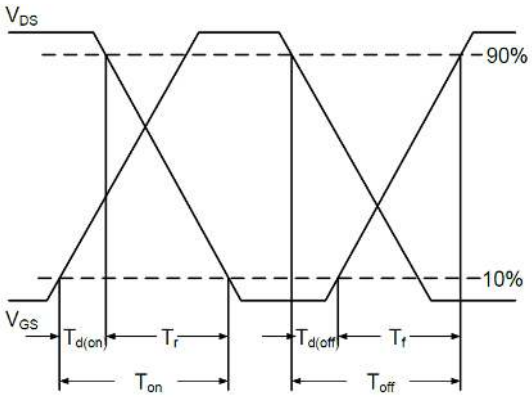


Figure 10. Switching Time Waveform

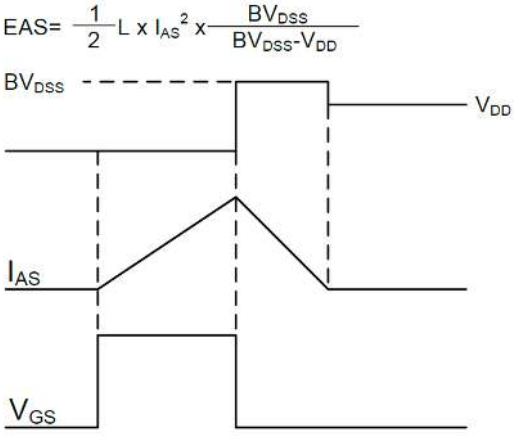
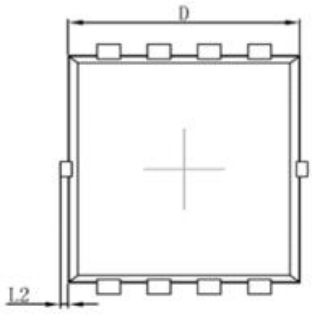
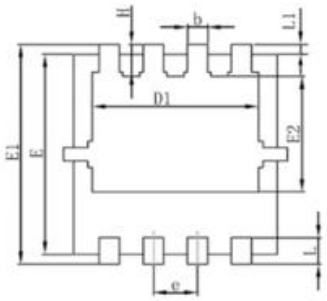


Figure 11. Unclamped Inductive Switching Waveform

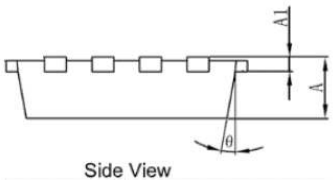
Mechanical Dimensions for PDFN3030-8L



Top View



Bottom View



Side View

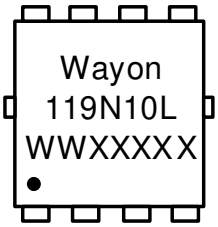
COMMON DIMENSIONS

SYMBOL	MM	
	MIN	MAX
A	0.70	0.90
A1	0.10	0.25
D	2.90	3.25
D1	2.25	2.69
E	2.90	3.20
E1	3.00	3.60
E2	1.54	2.20
b	0.20	0.40
e	0.60	0.70
L	0.15	0.50
L1	0.13BSC	
L2	0.00	0.20
H	0.15	0.65
θ	0°	14°

Ordering Information

Part	Package	Marking	Packing method
WMQ119N10LG2	PDFN3030-8L	119N10L	Tape and Reel

Marking Information



119N10L = Device code

WWXXXXX= Date code

Contact Information

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